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General Information

| | |
|--------------------------|----------------------------|
| Series | T494 |
| Dielectric | MnO2 Tantalum |
| Style | SMD Chip |
| Description | SMD, MnO2, Molded, Low ESR |
| Features | Low ESR |
| RoHS | Yes |
| Termination | Tin |
| Typical Component Weight | 652.04 mg |
| Shelf Life | 156 Weeks |
| MSL | 1 |

| Dimensions | |
|------------|--------------------|
| L | 7.3mm +/-0.3mm |
| W | 4.3mm +/-0.3mm |
| H | 4mm +/-0.3mm |
| T | 0.13mm REF |
| S | 1.3mm +/-0.3mm |
| F | 2.4mm +/-0.1mm |
| A | 3.6mm MIN |
| B | 0.5mm +/-0.15mm |
| E | 3.5mm REF |
| G | 3.5mm REF |
| P | 1.7mm REF |
| R | 1mm REF |
| X | 0.1mm +/-0.1mm REF |

| Specifications | |
|--------------------|---|
| Capacitance | 6.8 uF |
| Tolerance | 20% |
| Voltage DC | 50 VDC (85C), 33.5 VDC (125C) |
| Temperature Range | -55/+125°C |
| Rated Temperature | 85°C |
| Dissipation Factor | 6% 120Hz 25C |
| Failure Rate | N/A |
| ESR | 0.5 Ohms (100kHz 25C) |
| Ripple Current | 574 mA (rms, 100kHz 25C), 516.6 mA (rms, 85C), 229.6 mA (rms, 125C) |
| Leakage Current | 3.4 uA (5min 25°C) |

| Packaging Specifications | |
|--------------------------|------------|
| Packaging | T&R, 178mm |
| Packaging Quantity | 500 |

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